

IR2153/IR2153D

SELF-OSCILLATING HALF-BRIDGE DRIVER

Features

- Floating channel designed for bootstrap operation Fully operational to +600V
 Tolerant to negative transient voltage dV/dt immune
- Undervoltage lockout
- Programmable oscillator frequency

$$f = \frac{1}{1.4 \times (R_{T} + 75\Omega) \times C_{T}}$$

- Matched propagation delay for both channels
- Micropower supply startup current of 90 μA.
- Shutdown function turns off both channels
- Low side output in phase with R_T
- IR2153D has built in bootstrap diode

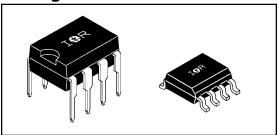
Description

The IR2153/IR2153D is a high voltage, high speed, self-oscillating power MOSFET and IGBT driver with both high and low side referenced output channels. Proprietary HVIC and latch immune CMOS technologies enable ruggedized monolithic construction. The front end features a programmable oscillator which is similar to the 555 timer. The output drivers feature a high pulse current buffer stage and an internal deadtime designed for minimum driver cross-conduction. Propagation delays for the two channels are

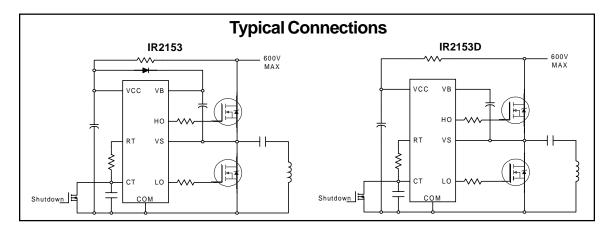
Product Summary

Voffset	600V max.
Duty Cycle	50%
l _O +/-	200 mA / 400 mA
V_{clamp}	15.6V
Deadtime (typ.)	1.2 µs

Packages



matched to simplify use in 50% duty cycle applications. The floating channel can be used to drive an N-channel power MOSFET or IGBT in the high side configuration that operates off a high voltage rail up to 600 volts. In IR2153D a bootstrap diode is included.



Absolute Maximum Ratings

Absolute Maximum Ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are absolute voltages referenced to COM. The Thermal Resistance and Power Dissipation ratings are measured under board mounted and still air conditions

				Value		
Symbol	Definition		Min.	Max.	Units	
V _B	High Side Floating Supply Voltage		-0.3	625		
Vs	High Side Floating Supply Offset Voltage		V _B - 25	V _B + 0.3		
V _{HO}	High Side Floating Output Voltage		V _S - 0.3	V _B + 0.3	V	
V _{LO}	Low Side Output Voltage		-0.3	V _{CC} + 0.3	V	
V _{RT}	R _T Voltage		-0.3	V _{CC} + 0.3		
VcT	C _T Voltage		-0.3	V _{CC} +0.3		
lcc	Supply Current (Note 1)		_	25	mA	
I _{RT}	R _T Output Current		-5	5	IIIA	
dV _S /dt	Allowable Offset Supply Voltage Transient		_	50	V/ns	
PD	Package Power Dissipation @ T _A ≤ +25°C (8 Lead DIP)	_	1.0	w	
	(8	Lead SOIC)	_	0.625] VV	
RthJA	Thermal Resistance, Junction to Ambient (8	3 Lead DIP)	_	125	°C/W	
	(8	Lead SOIC)	_	200	1 10/00	
TJ	Junction Temperature		_	150		
T _S	Storage Temperature		-55	150	°C	
TL	Lead Temperature (Soldering, 10 seconds)		_	300		

Recommended Operating Conditions

The Input/Output logic timing diagram is shown in Figure 1. For proper operation the device should be used within the recommended conditions. The V_S offset rating is tested with all supplies biased at 15V differential.

	Value		lue	
Symbol	Definition	Min.	Max.	Units
V _B	High Side Floating Supply Absolute Voltage	V _S + 10	V _S + 20	
Vs	High Side Floating Supply Offset Voltage	_	600	
V _{HO}	High Side Floating Output Voltage	Vs	V _B	\ \ \
V _{LO}	Low Side Output Voltage	0	Vcc	
Icc	Supply Current (Note 1)	_	5	mA
TA	Ambient Temperature	-40	125	°C

Note 1: Because of the IR2153's application specificity toward off-line supply systems, this IC contains a zener clamp structure between the chip V_{CC} and COM which has a nominal breakdown voltage of 15.6V. Therefore, the IC supply voltage is normally derived by forcing current into the supply lead (typically by means of a high value resistor connected between the chip V_{CC} and the rectified line voltage and a local decoupling capacitor from V_{CC} to COM) and allowing the internal zener clamp circuit to determine the nominal supply voltage. Therefore, this circuit should not be driven by a DC, low impedance power source of greater than V_{CLAMP}.

Dynamic Electrical Characteristics

 V_{BIAS} (V_{CC} , V_{BS}) = 12V, C_L = 1000 pF and T_A = 25°C unless otherwise specified.

		Value				
Symbol	Definition	Min.	Тур.	Max.	Units	Test Conditions
t _r	Turn-On Rise Time	_	80	_		
t _f	Turn-Off Fall Time	_	35	_	ns	
t _{sd}	Shutdown Propagation Delay	_	660			
DT	Deadtime	_	1.2	_	μs	
D	R _T Duty Cycle		50	_	%	

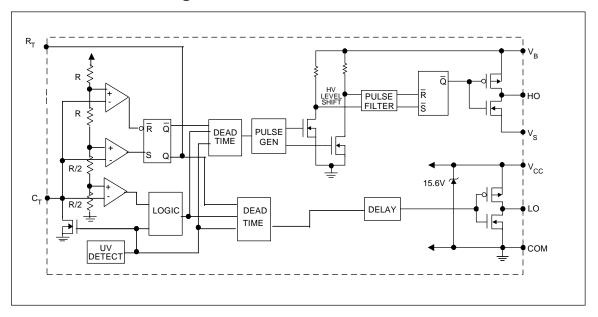
Static Electrical Characteristics

 V_{BIAS} (V_{CC}, V_{BS}) = 12V, C_L = 1000 pF, C_T = 1 nF and T_A = 25°C unless otherwise specified. The V_{IN}, V_{TH} and I_{IN} parameters are referenced to COM. The V_O and I_O parameters are referenced to COM and are applicable to the respective output leads: HO or LO.

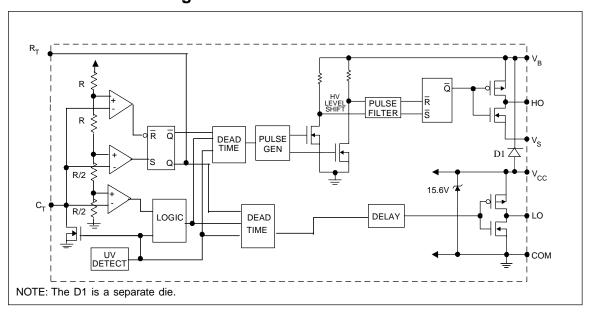
			Value			
Symbol	Definition	Min.	Тур.	Max.	Units	Test Conditions
fosc	Oscillator Frequency	_	20.0	_	kHz	$R_T = 35.7 \text{ k}\Omega$
			100	_	KHZ	$R_T = 7.04 \text{ k}\Omega$
V _{CLAMP}	V _{CC} Zener Shunt Clamp Voltage		15.6	_		$I_{CC} = 5 \text{ mA}$
V _{CT+}	2/3 V _{CC} Threshold	_	8.0	_	V	
V _{CT-}	1/3 V _{CC} Threshold	_	4.0	_	\ \	
V _{CTSD}	C _T shutdown Input Threshold		2.2	_		
V _{RT+}	R _T High Level Output Voltage, V _{CC} - R _T	l —	0	100		I _{RT} = -100 μA
		_	200	300		$I_{RT} = -1 \text{ mA}$
V _{RT-}	R _T Low Level Output Voltage		20	50		I _{RT} = 100 μA
		_	200	300	mV	I _{RT} = 1 mA
V _{OH}	High Level Output Voltage, V _{BIAS} - V _O	_	_	100	IIIV	I _O = 0A
V _{OL}	Low Level Output Voltage, V _O	_	_	100		I _O = 0A
I _{LK}	Offset Supply Leakage Current	_	_	50		$V_{B} = V_{S} = 600V$
I _{QBS}	Quiescent V _{BS} Supply Current	_	10	_		
I _{QCCUV}	Micropower V _{CC} Supply Startup Current	_	90	_	μA	$V_{CC} < V_{CCUV}$ $V_{CC} > V_{CCUV}$
I _{QCC}	Quiescent V _{CC} Supply Current	_	400	_		V _{CC} > V _{CCUV}
I _{CT}	C _T Input Current	_	0.001	1.0		
V _{CCUV+}	V _{CC} Supply Undervoltage Positive Going	_	9.0	_		
	Threshold				V	
V _{CCUV-}	V _{CC} Supply Undervoltage Negative Going	_	8.0	_	Ī	
	Threshold					
V _{CCUVH}	V _{CC} Supply Undervoltage Lockout Hysteresis	T —	1.0	_	V	
I _{O+}	Output High Short Circuit Pulsed Current	T —	200	_	mA	$V_O = 0V$
I _{O-}	Output Low Short Circuit Pulsed Current	_	400	_		V _O = 15V

IR2153/IR2153D

Functional Block Diagram for IR2153



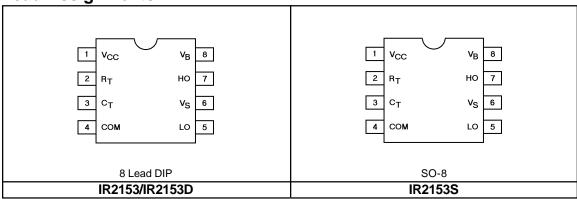
Functional Block Diagram for IR2153D



Lead Definitions

Le	ad				
Symbol	Description				
R _T	Oscillator timing resistor input,in phase with HO for normal IC operation				
C _T	Oscillator timing capacitor input, the oscillator frequency according to the following equation:				
	$f = \frac{1}{1.4 \times (R_T + 75\Omega) \times C_T}$				
	where 75 Ω is the effective impedance of the R _T output stage				
V _B	High side floating supply				
НО	High side gate drive output				
VS	High side floating supply return				
V _C C	Low side and logic fixed supply				
LO	Low side gate drive output				
COM	Low side return				

Lead Assignments



NOTE: The IR2153D is offered in 8 lead DIP only.

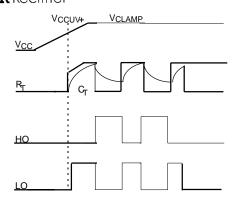
IR2153/IR2153D

Device Information

Process & Design Rule			HVDCMOS 4.0 μm		
Transistor Count			231		
Die Size	Die Size		68 X 101 X 26 (mil)		
Die Outline					
Thickness	of Gate Oxide		800Å		
Connection		Material	Poly Silicon		
	First	Width	5 μm		
	Layer	Spacing	6 µm		
	•	Thickness	5000Å		
		Material	Al - Si - Cu (Si: 1.0%, Cu: 0.5%)		
	Second	Width	6 μm		
	Layer	Spacing	9 μm		
		Thickness	20,000Å		
Contact Ho	le Dimension		5 μm X 5 μm		
Insulation L	ayer	Material	PSG (SiO ₂)		
		Thickness	1.7 µm		
Passivation	1	Material	PSG (SiO ₂)		
		Thickness	1.7 µm		
Method of S	Saw		Full Cut		
Method of I	Die Bond		Ablebond 84 - 1		
Wire Bond		Method	Thermo Sonic		
			Au (1.0 mil / 1.3 mil)		
Leadframe		Material	Cu		
		Die Area	Ag		
		Lead Plating	Pb : Sn (37 : 63)		
Package			8 Lead PDIP / SO-8		
	Materials		EME6300 / MP150 / MP190		
Remarks:					

International **TOR** Rectifier

IR2153/IR2153D



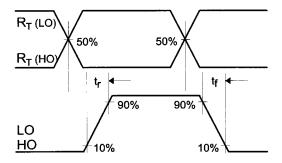


Figure 1. Input/Output Timing Diagram

Figure 2. Switching Time Waveform Definitions

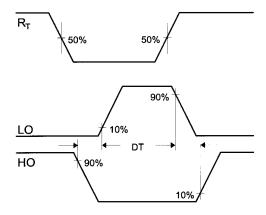
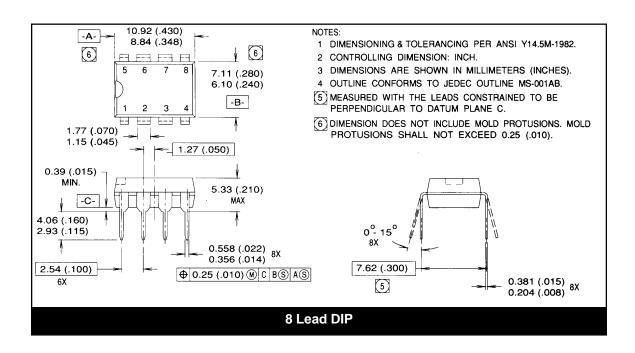
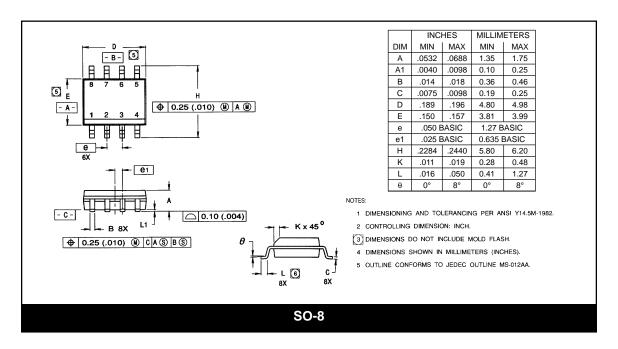


Figure 3. Deadtime Waveform Definitions





International

TOR Rectifier

IR2153/IR2153D



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